

12-02-2005



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Docket No. JCLA15479

Form 1595
1-31-92

RECORDATION FORM COVER SHEET

U.S. Department of Commerce
Patent and Trademark Office

PATENTS ONLY

To the Honorable Assistant Commissioner for Patents: Please record the attached
original documents or copy thereof.

11219 U.S. PTO
11/285437



112105

11/21/05

1. Name of conveying party(ies):
Sheng-Chi Tsao

2. Name/address of receiving Party(ies):
VIA Technologies, Inc.

3. Nature of conveyance: Assignment
 Merger Security Agreement Other
 Change of Name Reassignment

8F, No. 535, Chung-Cheng Rd.,
Hsin-Tien City, Taipei Hsien,
Taiwan, R.O.C.

4. Date(s) of execution: November 17, 2005.

Add'l names of receiving parties
Attached? Yes No

5. Application number(s) or patent number(s):
If this documents is being filed together with a new application, the execution date of the application is November 17, 2005.

A. Patent Application No. (s)

B. Patent No. (s)

Additional numbers attached? Yes No

6. Name and address of party to whom Correspondence concerning document should be mailed:

J.C. Patents, Inc.
4 Venture, Suite 250
Irvine, CA 92618
(949) 660-0761

7. Total No. of applications and patents involved:
ONE(1)

8. Total fee (37 CFR §3.41): \$40.00
 Enclosed
 Charge to Acct. No. _____

9. Total number of pages, including Cover sheet, attachments and document 3.

DO NOT USE THIS SPACE

10. Statement and Signature:

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Jiawei Huang
Name of Person Signing

[Signature]
Signature

11/21/2005
Date

Registration No. 43,330

12/01/2005 ECOOPER 00000099 11285437

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ASSIGNMENT

WHEREAS,

1. Sheng-Chi Tsao

hereinafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: **AN APPARATUS WITH AND A METHOD FOR A DYNAMIC INTERFACE
PROTOCOL**

Filed: Serial No.

Executed concurrently with the execution of this instrument

WHEREAS, VIA Technologies, Inc.
of 8F, No. 535, Chung-Cheng Rd., Hsin-Tien City, Taipei Hsien, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

ASSIGNMENT CONTINUED

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Signature: Sheng-Chi Tsao

Date: Nov. 17, 2005

Sole or First Joint Inventor: Sheng-Chi Tsao